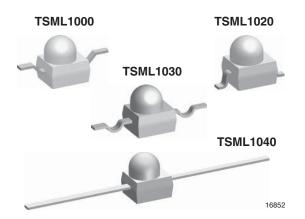


Vishay Semiconductors

High Power Infrared Emitting Diode, RoHS Compliant, 940 nm, GaAlAs/GaAs



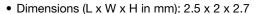
DESCRIPTION

TSML1000 is an infrared, 940 nm emitting diode in GaAlAs/GaAs with high radiant power molded in a clear, untinted plastic package (with lens) for surface mounting (SMD).

FEATURES

· Package type: surface mount





• Peak wavelength: λ_p = 940 nm

· High radiant power

High radiant intensity

• Angle of half intensity: $\varphi = \pm 12^{\circ}$

Low forward voltage

· Suitable for high pulse current operation

· Good spectral matching with Si photodetectors

· Versatile terminal configurations

Package matches with detector TEMT1000

• Floor life: 168 h, MSL 3, acc. J-STD-020

 Compliant to RoHS Directive 2002/95/EC and in accordance with WEEE 2002/96/EC

APPLICATIONS

- · For remote control
- Punched tape readers
- Encoder
- Photointerrupters

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (deg)	λ _P (nm)	t _r (ns)
TSML1000	7	± 12	940	800
TSML1020	7	± 12	940	800
TSML1030	7	± 12	940	800
TSML1040	7	± 12	940	800

Note

· Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	RDERING CODE PACKAGING REMARKS		PACKAGE FORM		
TSML1000	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Reverse gullwing		
TSML1020	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Gullwing		
TSML1030	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Yoke		
TSML1040	Bulk	MOQ: 1000 pcs, 1000 pcs/bulk	Axial leads		

Note

• MOQ: minimum order quantity

Soldering temperature

Thermal resistance junction/ambient

TSML1000, TSML1020, TSML1030, TSML1040

 T_{sd}

 R_{thJA}

120

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°C

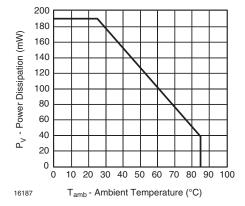
°C

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	200	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1.0	А	
Power dissipation		P _V	190	mW	
Junction temperature		T _j	100	°C	
Operating temperature range		T _{amb}	- 40 to + 85	°C	
Storage temperature range		T _{stq}	- 40 to + 100	°C	

 $t \leq 5 \; \text{s}$

Soldered on PCB, pad dimensions:

4 mm x 4 mm



100 (Pu) 100

< 260

400

Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

Fig. 2 - Forward Current vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V _F		1.2	1.5	V
	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	V _F		2.6		V
Temperature coefficient of V _F	I _F = 1 mA	TK _{VF}		- 1.8		mV/K
Reverse current	V _R = 5 V	I _R			10	μΑ
Junction capacitance	V _R = 0 V, f = 1 MHz, E = 0	Cj		25		pF
Radiant intensity	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	l _e	3	7	15	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	φ _e		35		mW
Temperature coefficient of φ _e	I _F = 20 mA	TKφ _e		- 0.6		%/K
Angle of half intensity		φ		± 12		deg
Peak wavelength	I _F = 100 mA	λ_{p}		940		nm
Spectral bandwidth	I _F = 100 mA	Δλ		50		nm
Temperature coefficient of λ_p	I _F = 100 mA	TKλ _p		0.2		nm/K
Rise time	I _F = 100 mA	t _r		800		ns
Fall time	I _F = 100 mA	t _f		800		ns
Virtual source diameter		d		1.2		mm

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

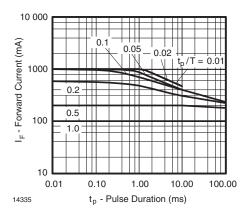


Fig. 3 - Pulse Forward Current vs. Pulse Duration

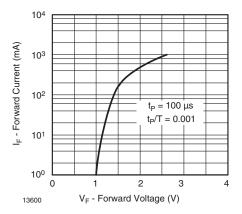


Fig. 4 - Forward Current vs. Forward Voltage

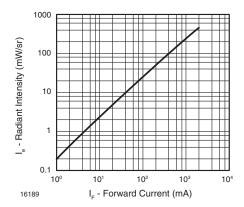


Fig. 5 - Radiant Intensity vs. Forward Current

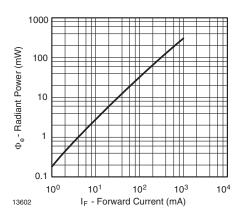


Fig. 6 - Radiant Power vs. Forward Current

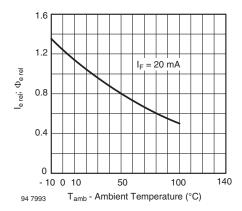


Fig. 7 - Relative Radiant Intensity/Power vs. Ambient Temperature

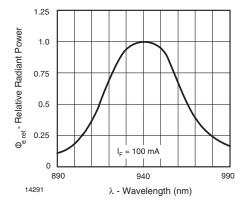


Fig. 8 - Relative Radiant Power vs. Wavelength





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REFLOW SOLDER PROFILE

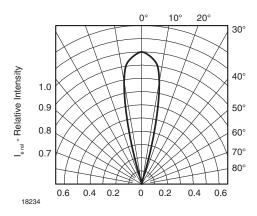


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

PRECAUTIONS FOR USE

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (burn out will happen).

2. Storage

- 2.1 Storage temperature and rel. humidity conditions are: 5 °C to 35 °C, R.H. 60 %.
- 2.2 Floor life must not exceed 168 h, acc. to JEDEC level 3, J-STD-020.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with desiccant.

Considering tape life, we suggest to use products within one year from production date.

- 2.3 If opened more than one week in an atmosphere 5 °C to 35 °C, R.H. 60 %, devices should be treated at 60 °C ± 5 °C for 15 h.
- 2.4 If humidity indicator in the package shows pink color (normal blue), then devices should be treated with the same conditions as 2.3.

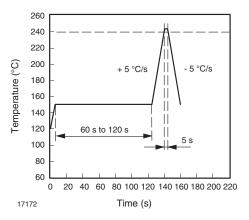
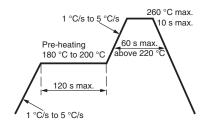


Fig. 10 - Lead Tin (SnPb) Reflow Solder Profile



22566

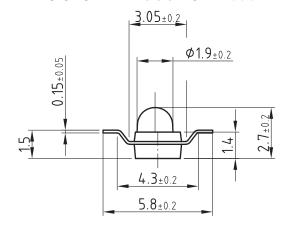
Fig. 11 - Lead (Pb)-Free Reflow Solder Profile acc. J-STD-020



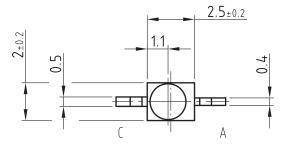
TSML1000, TSML1020, TSML1030, TSML1040

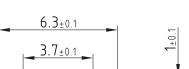
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PACKAGE DIMENSIONS in millimeters: TSML1000









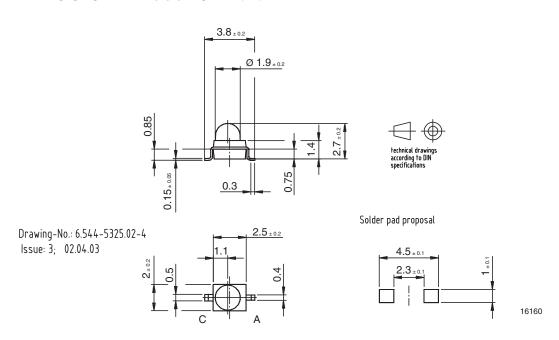
Solder pad proposal

Drawing-No.: 6.544-5326.02-4

Issue: 3: 02.04.03

16159

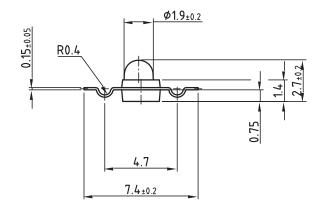
PACKAGE DIMENSIONS in millimeters: TSML1020





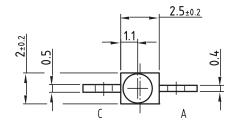
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PACKAGE DIMENSIONS in millimeters: TSML1030

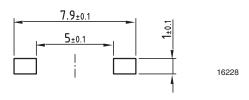


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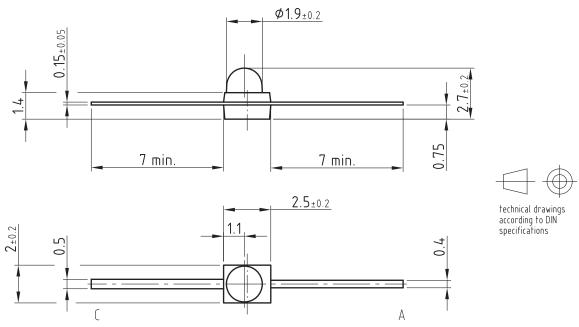




Solder pad proposal



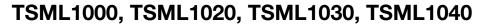
PACKAGE DIMENSIONS in millimeters: TSML1040



Drawing-No.: 6.544-5339.02-4

Issue: 3; 02.04.03

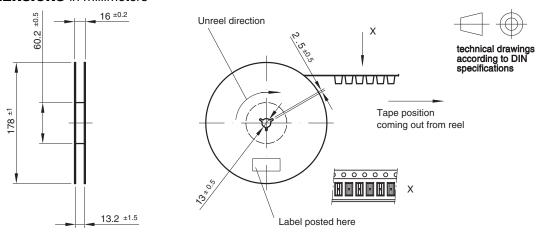
16760



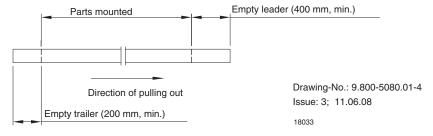


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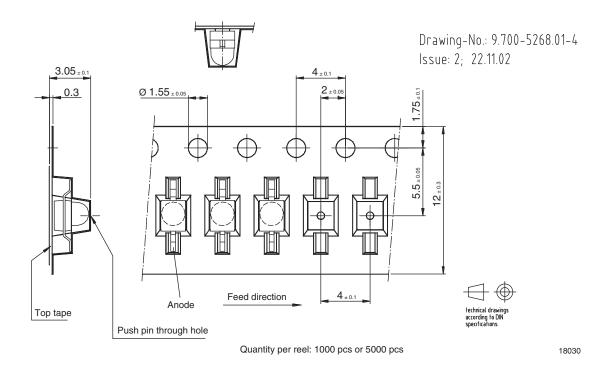
REEL DIMENSIONS in millimeters



Leader and trailer tape:

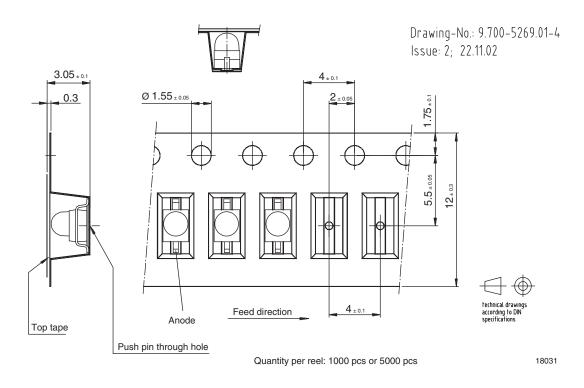


TAPING DIMENSIONS in millimeters: TSML1000

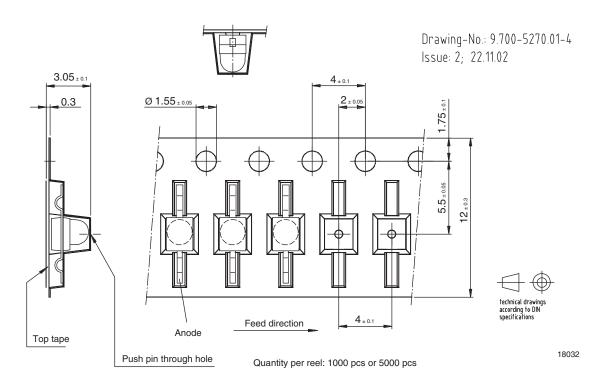


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TAPING DIMENSIONS in millimeters: **TSML1020**



TAPING DIMENSIONS in millimeters: TSML1030







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